## **Zener Voltage Regulators**

### 500 mW SOD-123 Surface Mount

Three complete series of Zener diodes are offered in the convenient, surface mount plastic SOD-123 package. These devices provide a convenient alternative to the leadless 34-package style.

#### **Features**

- 500 mW Rating on FR-4 or FR-5 Board
- Wide Zener Reverse Voltage Range 1.8 V to 43 V
- Package Designed for Optimal Automated Board Assembly
- Small Package Size for High Density Applications
- ESD Rating of Class 3 (> 16 kV) per Human Body Model
- Peak Power 225 W (8 x 20 μs)
- AEC-Q101 Qualified and PPAP Capable
- SZ Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements
- Pb-Free Packages are Available\*

### **Mechanical Characteristics:**

CASE: Void-free, transfer-molded, thermosetting plastic case

FINISH: Corrosion resistant finish, easily solderable

### MAXIMUM CASE TEMPERATURE FOR SOLDERING PURPOSES:

260°C for 10 Seconds

**POLARITY:** Cathode indicated by polarity band

FLAMMABILITY RATING: UL 94 V-0

### **MAXIMUM RATINGS**

Rating	Symbol	Max	Unit
Peak Power Dissipation @ 20 μs (Note 1) @ T <sub>L</sub> ≤ 25°C	P <sub>pk</sub>	225	W
Total Power Dissipation on FR–5 Board, (Note 2) @ T <sub>L</sub> = 75°C Derated above 75°C	P <sub>D</sub>	500 6.7	mW mW/°C
Thermal Resistance, (Note 3) Junction-to-Ambient	$R_{\theta JA}$	340	°C/W
Thermal Resistance, (Note 3) Junction-to-Lead	$R_{ heta JL}$	150	°C/W
Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	–55 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

- 1. Nonrepetitive current pulse per Figure 11.
- 2.  $FR-5 = 3.5 \times 1.5$  inches, using the minimum recommended footprint.
- 3. Thermal Resistance measurement obtained via infrared Scan Method.

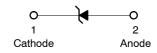


### ON Semiconductor®

http://onsemi.com



SOD-123 CASE 425 STYLE 1



### **MARKING DIAGRAM**



xxx = Device Code (Refer to page 2)

M = Date Code ■ = Pb-Free Package

(Note: Microdot may be in either location)

### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MMSZ4xxxET1G	SOD-123 (Pb-Free)	3,000 / Tape & Reel
SZMMSZ4xxxET1G	SOD-123 (Pb-Free)	3,000 / Tape & Reel
MMSZ4xxxET3G	SOD-123 (Pb-Free)	10,000 / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

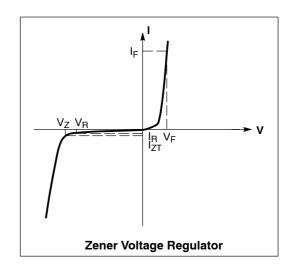
### **DEVICE MARKING INFORMATION**

See specific marking information in the device marking column of the Electrical Characteristics table on page 2 of this data sheet.

<sup>\*</sup>For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

## **ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise noted, $V_F = 0.95$ V Max. @ $I_F = 10$ mA)

Symbol	Parameter			
VZ	Reverse Zener Voltage @ I <sub>ZT</sub>			
I <sub>ZT</sub>	Reverse Current			
I <sub>R</sub>	Reverse Leakage Current @ V <sub>R</sub>			
V <sub>R</sub>	Reverse Voltage			
Ι <sub>Ε</sub>	Forward Current			
V <sub>F</sub>	Forward Voltage @ I <sub>F</sub>			



### **ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise noted, $V_F = 0.9$ V Max. @ $I_F = 10$ mA)

		Zener Voltage (Note 1)				Leakage Current	
	Device	V <sub>Z</sub> (V)			@ I <sub>ZT</sub>	I <sub>R</sub> @	V <sub>R</sub>
Device*	Marking	Min	Nom	Max	μА	μА	V
MMSZ4680ET1G	CF8	2.09	2.2	2.31	50	4	1
MMSZ4684ET1G	CG3	3.13	3.3	3.47	50	7.5	1.5
MMSZ4688ET1G	CG7	4.47	4.7	4.94	50	10	3
MMSZ4689ET1G	CG8	4.85	5.1	5.36	50	10	3
MMSZ4690ET1G	CG9	5.32	5.6	5.88	50	10	4
MMSZ4691ET1G	CH1	5.89	6.2	6.51	50	10	5
MMSZ4692ET1G	CH2	6.46	6.8	7.14	50	10	5.1
MMSZ4693ET1G	СНЗ	7.13	7.5	7.88	50	10	5.7
MMSZ4697ET1G	CH7	9.50	10	10.50	50	1	7.6
MMSZ4699ET1G	CH9	11.40	12	12.60	50	0.05	9.1
MMSZ4701ET1G	CJ2	13.3	14	14.7	50	0.05	10.6
MMSZ4702ET1G	CJ3	14.25	15	15.75	50	0.05	11.4
MMSZ4703ET1G	CJ4	15.20	16	16.80	50	0.05	12.1
MMSZ4705ET1G	CJ6	17.10	18	18.90	50	0.05	13.6
MMSZ4709ET1G	CK1	22.80	24	25.20	50	0.01	18.2
MMSZ4711ET1G	СКЗ	25.65	27	28.35	50	0.01	20.4
MMSZ4717ET1G	CK9	40.85	43	45.15	50	0.01	32.6

<sup>1.</sup> Nominal Zener voltage is measured with the device junction in thermal equilibrium at  $T_L = 30^{\circ}C \pm 1^{\circ}C$ .

<sup>\*</sup>Include SZ-prefix devices where applicable.

### **TYPICAL CHARACTERISTICS**

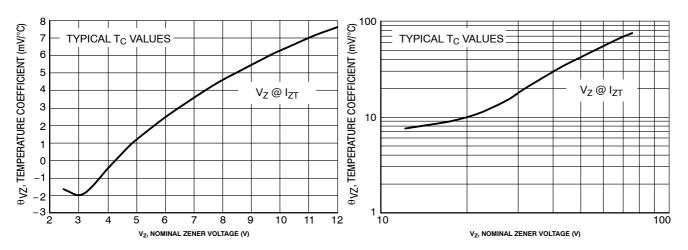


Figure 1. Temperature Coefficients (Temperature Range – 55°C to +150°C)

Figure 2. Temperature Coefficients (Temperature Range – 55°C to +150°C)

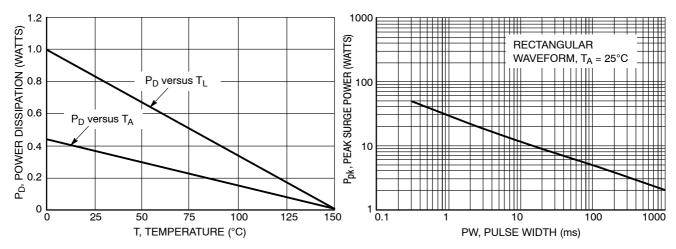


Figure 3. Steady State Power Derating

Figure 4. Maximum Nonrepetitive Surge Power

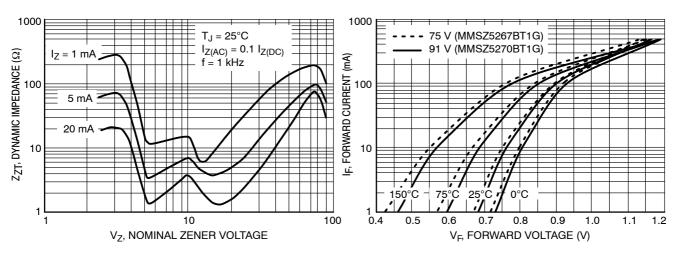


Figure 5. Effect of Zener Voltage on Zener Impedance

Figure 6. Typical Forward Voltage

### **TYPICAL CHARACTERISTICS**

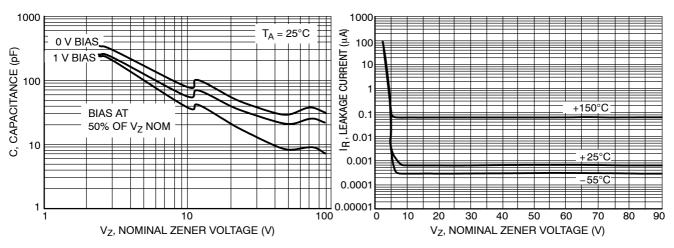


Figure 7. Typical Capacitance

Figure 8. Typical Leakage Current

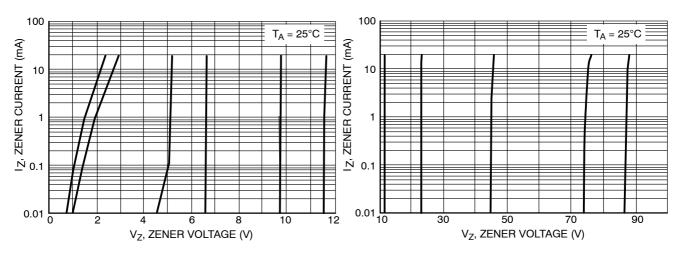


Figure 9. Zener Voltage versus Zener Current (V<sub>Z</sub> Up to 12 V)

Figure 10. Zener Voltage versus Zener Current (12 V to 91 V)

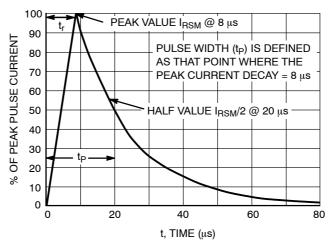


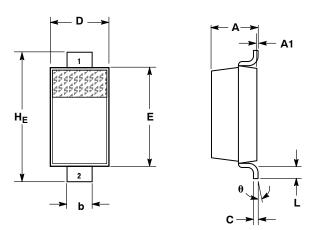
Figure 11. 8  $\times$  20  $\mu s$  Pulse Waveform



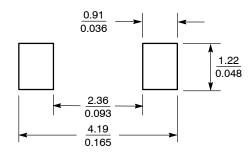
SOD-123 CASE 425-04 ISSUE G

**DATE 07 OCT 2009** 





### **SOLDERING FOOTPRINT\***



SCALE 10:1

- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ANSI
- Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.

	MILLIMETERS			INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α	0.94	1.17	1.35	0.037	0.046	0.053	
A1	0.00	0.05	0.10	0.000	0.002	0.004	
b	0.51	0.61	0.71	0.020	0.024	0.028	
C			0.15			0.006	
D	1.40	1.60	1.80	0.055	0.063	0.071	
Е	2.54	2.69	2.84	0.100	0.106	0.112	
HE	3.56	3.68	3.86	0.140	0.145	0.152	
L	0.25			0.010			
θ	0°		10°	0°		10°	

### **GENERIC MARKING DIAGRAM\***



XXX = Specific Device Code

= Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " •", may or may not be present.

STYLE 1: PIN 1. CATHODE 2. ANODE

DOCUMENT NUMBER:	98ASB42927B	Electronic versions are uncontrolled except when accessed directly from the Document Repositor Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.		
DESCRIPTION:	SOD-123		PAGE 1 OF 1	

ON Semiconductor and (III) are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

<sup>\*</sup>For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

onsemi, ONSEMI., and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <a href="www.onsemi.com/site/pdf/Patent-Marking.pdf">www.onsemi.com/site/pdf/Patent-Marking.pdf</a>. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems. or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

### ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

 $\textbf{Technical Library:} \ \underline{www.onsemi.com/design/resources/technical-documentation}$ 

onsemi Website: www.onsemi.com

ONLINE SUPPORT: www.onsemi.com/support

For additional information, please contact your local Sales Representative at

www.onsemi.com/support/sales